
150mA Voltage Regulator (Wide Input Voltage Range)

NO.EA-100-151027

OUTLINE

The R1154x series are CMOS-based voltage regulator (VR) ICs. The R1154x has features of high output voltage accuracy and ultra-low supply current. A peak current limit circuit, a short current limit circuit, and a thermal shutdown circuit are built in the R1154x series.

The regulator output voltage is fixed in the R1154xxxB, while adjustable type is the R1154x001C.

Output voltage accuracy is $\pm 2.0\%$.

Since the packages for these ICs are DFN1616-6, SOT-23-5, and SOT-89-5, high density mounting of the ICs on boards is possible.

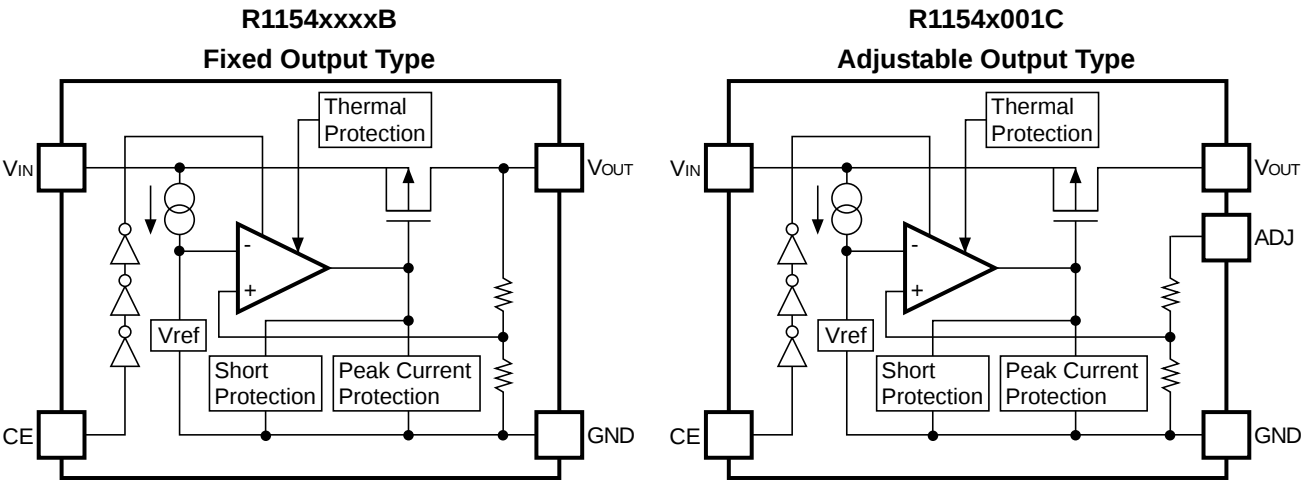
FEATURES

- Supply Current Typ. $5.0\mu\text{A}$
- Standby Current Typ. $0.1\mu\text{A}$
- Output Voltage Accuracy $\pm 2.0\%$
- Wide Output Voltage Range 2.5V to 12.0V (0.1V steps) (xxxB)
adjustable in the range of 2.5V to V_{IN} or 24.0V (001C)
(For other voltages, please refer to MARK INFORMATION.)
- Input Voltage Max. 24.0V
- Output Current Min. 140mA ($V_{\text{IN}}=V_{\text{OUT}}+2.0\text{V}$, 2.5V Output type)
Min. 150mA ($V_{\text{IN}}=V_{\text{OUT}}+2.0\text{V}$, 3.0V Output type)
- Package DFN1616-6, SOT-23-5, SOT-89-5
- Built-in Peak Current Limit Circuit
- Built-in Short Current Limit Circuit
- Built-in Thermal Shutdown Circuit

APPLICATIONS

- Power source for home appliances such as refrigerators, rice cookers, Electronic water warmers, etc.
- Power source for car audio equipment, car navigation system, and ETC system.
- Power source for notebook PCs, digital TVs, cordless phones, and LAN system.
- Power source for copiers, printers, facsimiles, and scanners.

BLOCK DIAGRAMS

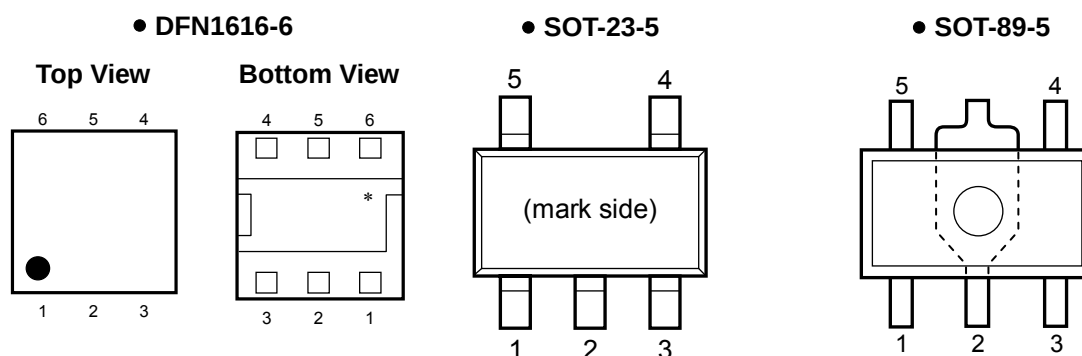


SELECTION GUIDE

The output voltage can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1154Lxxx*-TR	DFN1616-6	5,000 pcs	Yes	Yes
R1154Nxxx*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes
R1154Hxxx*-T1-FE	SOT-89-5	1,000 pcs	Yes	Yes
xxx : The output voltage can be designated in the range from 2.5V(025) to 12.0V(120) in 0.1V steps. (For other voltages, please refer to MARK INFORMATIONs.) The output voltage adjustable type is fixed at 001 (Reference voltage=2.5V)				
* : (B) Fixed Output Type (C) Adjustable Output Type				

PIN CONFIGURATION



PIN DESCRIPTION

• DFN1616-6

Pin No	Symbol	Description	
1	V_{DD}	Input Pin	
2	NC	No Connection	
3	V_{OUT}	Voltage Regulator Output Pin	
4	CE	Chip Enable Pin	
5	NC	R1154LxxxB (B version)	No Connection
	ADJ	R1154L001C (C version)	Reference Voltage of Adjustable Output Pin
6	GND	Ground Pin	

*) Tab is GND level. (They are connected to the reverse side of this IC.)

The tab is better to be connected to the GND, but leaving it open is also acceptable.

• SOT-23-5

Pin No	Symbol	Description	
1	V_{OUT}	Voltage Regulator Output Pin	
2	GND	Ground Pin	
3	V_{DD}	Input Pin	
4	NC	R1154NxxxB (B version)	No Connection
	ADJ	R1154N001C (C version)	Reference Voltage of Adjustable Output Pin
5	CE	Chip Enable Pin	

• SOT-89-5

Pin No	Symbol	Description	
1	V_{OUT}	Voltage Regulator Output Pin	
2	GND	Ground Pin	
3	CE	Chip Enable Pin	
4	NC	R1154HxxxB (B version)	No Connection
	ADJ	R1154H001C (C version)	Reference Voltage of Adjustable Output Pin
5	V_{DD}	Input Pin	

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	26.0	V
V_{CE}	Input Voltage (CE Input Pin)	-0.3 to $V_{IN}+0.3$	V
V_{OUT}	Output Voltage	-0.3 to $V_{IN}+0.3$	V
V_{ADJ}	Output Voltage (ADJ Pin)	-0.3 to $V_{IN}+0.3$	V
I_{OUT}	Output Current	250	mA
P_D	Power Dissipation (DFN1616-6)*	640	mW
	Power Dissipation (SOT-23-5)*	420	
	Power Dissipation (SOT-89-5)*	900	
T_{opt}	Operating Temperature	-40 to $+105$	$^{\circ}\text{C}$
T_{stg}	Storage Temperature	-55 to $+125$	$^{\circ}\text{C}$

*) For Power Dissipation please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.

The functional operation at or over these absolute maximum ratings is not assured.

POWER DISSIPATION (DFN1616-6)

This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

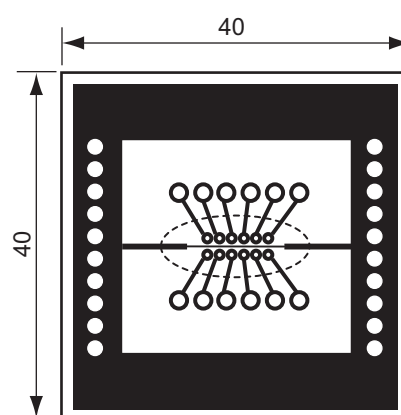
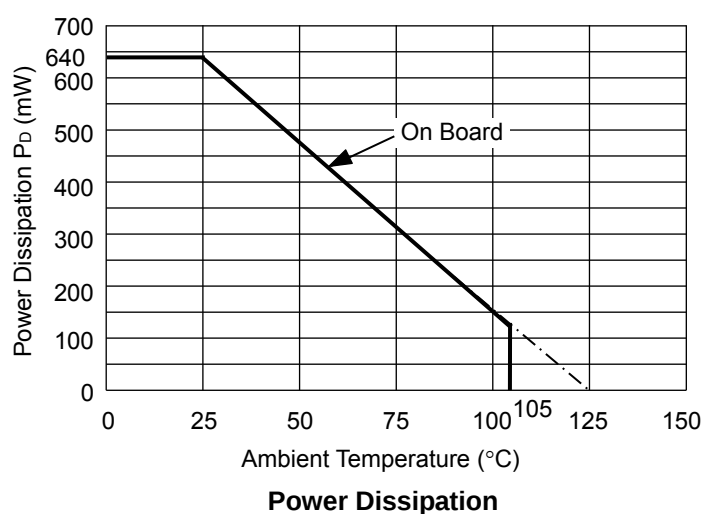
Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plastic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-holes	φ0.5mm × 32pcs

Measurement Results

($T_{opt}=25^{\circ}\text{C}$, $T_{jmax}=125^{\circ}\text{C}$)

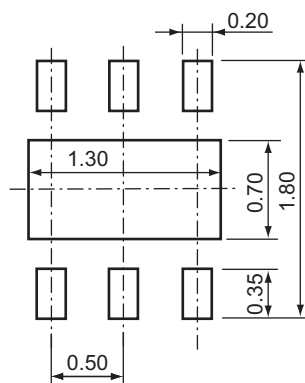
	Standard Land Pattern
Power Dissipation	640mW
Thermal Resistance	$\theta_{ja}=(125-25^{\circ}\text{C})/0.64\text{W}=156^{\circ}\text{C/W}$
Thermal Resistance	$\theta_{jc}=23^{\circ}\text{C/W}$



Measurement Board Pattern

○ IC Mount Area (Unit: mm)

RECOMMENDED LAND PATTERN



(Unit: mm)

POWER DISSIPATION (SOT-23-5)

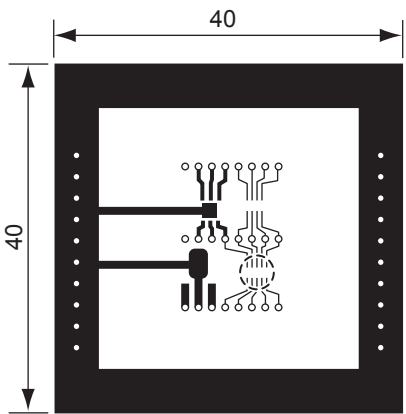
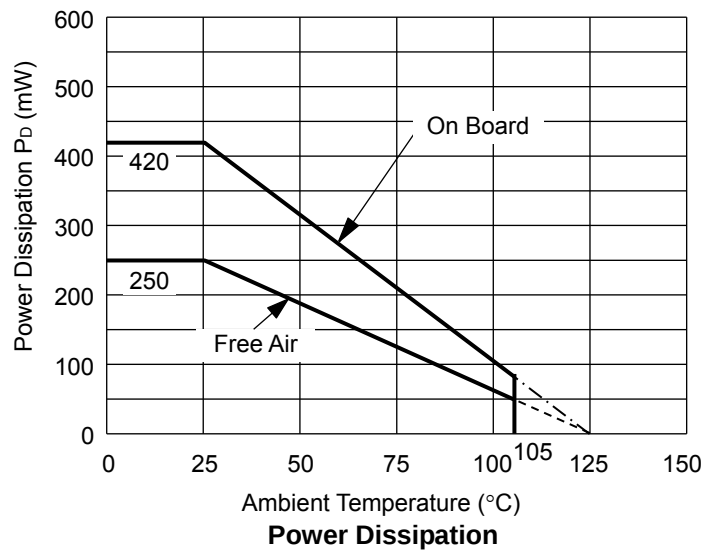
This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:
(Power Dissipation (SOT-23-5) is substitution of SOT-23-6.)

Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plastic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-holes	φ0.5mm × 44pcs

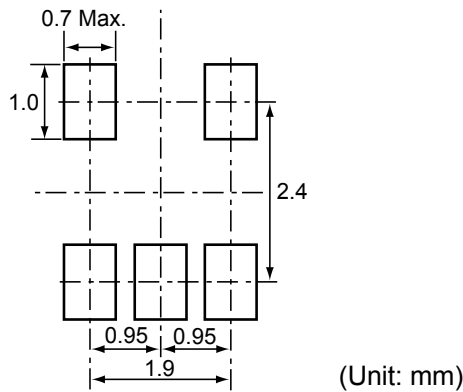
Measurement Results (T_{opt}=25°C, T_{jmax}=125°C)

	Standard Land Pattern	Free Air
Power Dissipation	420mW	250mW
Thermal Resistance	θ _{ja} =(125-25°C)/0.42W=238°C/W	400°C/W



Measurement Board Pattern
○ IC Mount Area (Unit: mm)

RECOMMENDED LAND PATTERN



POWER DISSIPATION (SOT-89-5)

This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

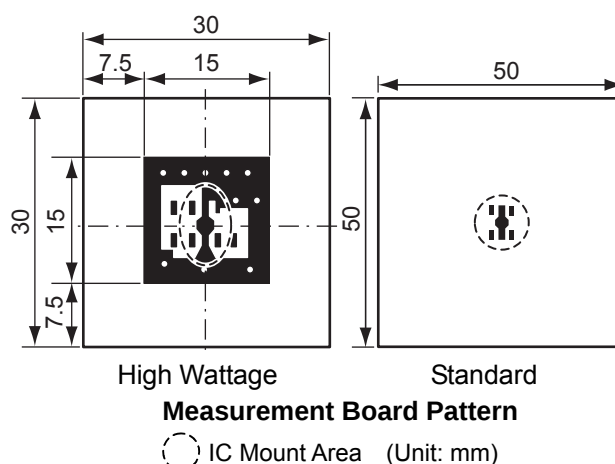
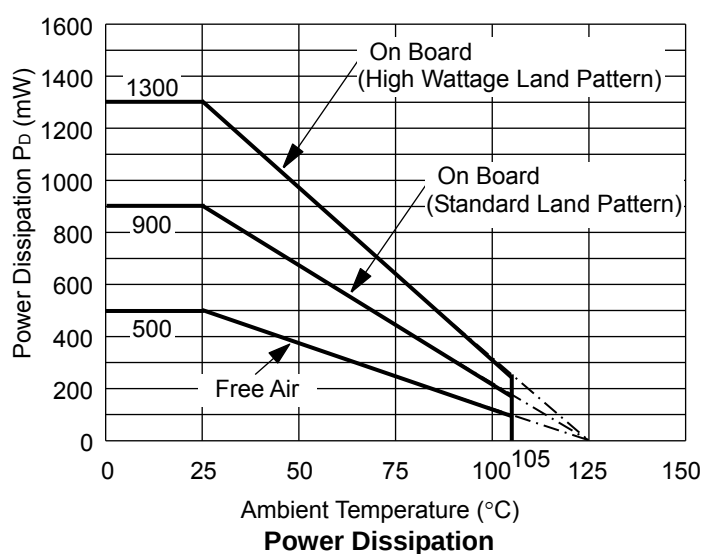
Measurement Conditions

	High Wattage Land Pattern	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plastic (Double sided)	Glass cloth epoxy plastic (Double sided)
Board Dimensions	30mm × 30mm × 1.6mm	50mm × 50mm × 1.6mm
Copper Ratio	Top side : Approx. 20% , Back side : Approx. 100%	Top side : Approx. 10% , Back side : Approx. 100%
Through-holes	φ0.85mm × 10pcs	—

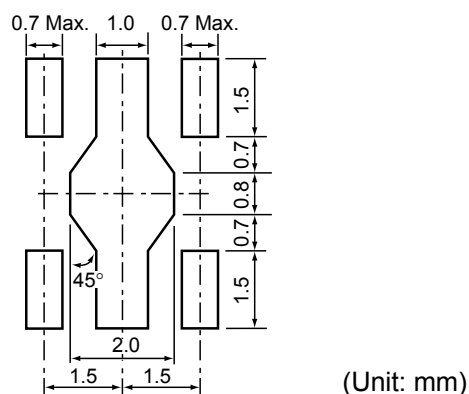
Measurement Results

($T_{opt}=25^{\circ}\text{C}$, $T_{jmax}=125^{\circ}\text{C}$)

	High Wattage Land Pattern	Standard Land Pattern	Free Air
Power Dissipation	1300mW	900mW	500mW
Thermal Resistance	77°C/W	111°C/W	200°C/W



RECOMMENDED LAND PATTERN



ELECTRICAL CHARACTERISTICS

• R1154xxxxB

T_{opt}=25°C

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V _{IN}	Input Voltage				24	V
V _{OUT}	Output Voltage	V _{IN} =V _{SET} +2.0V, I _{OUT} =20mA	×0.98		×1.02	V
I _{OUT}	Output Current	V _{IN} -V _{SET} =2.0V	Refer to the following table			
I _{SS}	Supply Current	V _{IN} =V _{CE} , V _{IN} -V _{SET} =2.0V		5	10	μA
I _{standby}	Standby Current	V _{IN} =24V, V _{CE} =0V		0.1	1.0	μA
ΔV _{OUT} / ΔI _{OUT}	Load regulation	V _{IN} -V _{SET} =2.0V, 1mA ≤ I _{OUT} ≤ 40mA	Refer to the following table			
ΔV _{OUT} / ΔV _{IN}	Line regulation	I _{OUT} =20mA V _{SET} +1V ≤ V _{IN} ≤ 24V		0.05	0.20	%/V
V _{DIF}	Dropout Voltage	I _{OUT} =20mA	Refer to the following table			
ΔV _{OUT} / ΔT _{opt}	Output Voltage Temperature Coefficient	V _{IN} -V _{SET} =2.0V, I _{OUT} =20mA -40°C ≤ T _{opt} ≤ 105°C		±100		ppm/°C
I _{SC}	Short Current Limit	V _{OUT} =0V		45		mA
V _{CEH}	CE "H" Input Voltage		2.1		V _{IN}	V
V _{CEL}	CE "L" Input Voltage		0		0.3	V
T _{SD}	Thermal Shutdown Temperature	Junction Temperature		150		°C
T _{SR}	Thermal Shutdown Released Temperature	Junction Temperature		125		°C

• Output Current (T_{opt}=25°C)

Set Output Voltage V _{SET} (V)	Output Current (mA)
	Min.
2.5 ≤ V _{SET} ≤ 2.9	140
3.0 ≤ V _{SET} ≤ 12.0	150

• Load Regulation (T_{opt}=25°C)

Set Output Voltage V _{OUT} (V)	Load Regulation (mV)	
	Typ.	Max.
2.5 ≤ V _{SET} ≤ 3.0	20	50
3.1 ≤ V _{SET} ≤ 5.0	30	75
5.1 ≤ V _{SET} ≤ 12.0	40	115

• Dropout Voltage (T_{opt}=25°C)

Set Output Voltage V _{OUT} (V)	Dropout Voltage (V)	
	Typ.	Max.
2.5 ≤ V _{SET} ≤ 7.0	0.20	0.40
7.1 ≤ V _{SET} ≤ 10.0	0.25	0.50
10.1 ≤ V _{SET} ≤ 12.0	0.30	0.55

● R1154x001C

$T_{opt}=25^{\circ}\text{C}$

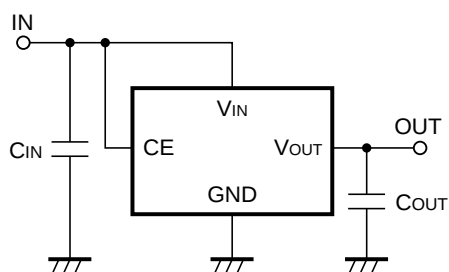
Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V_{IN}	Input Voltage				24	V
V_{OUT}	Output Voltage	$V_{IN}=V_{SET}+2.0\text{V}$, $I_{OUT}=20\text{mA}$	2.45	2.50	2.55	V
I_{OUT}	Output Current	$V_{IN}=V_{SET}+2.0\text{V}$	140			mA
I_{SS}	Supply Current	$V_{IN}=V_{SET}+2.0\text{V}$, $V_{CE}=V_{IN}$		5	10	μA
$I_{standby}$	Standby Current	$V_{IN}=24\text{V}$, $V_{CE}=0\text{V}$		0.1	1.0	μA
$\Delta V_{OUT}/\Delta I_{OUT}$	Load regulation	$V_{IN}=V_{SET}+2.0\text{V}$, $1\text{mA} \leq I_{OUT} \leq 40\text{mA}$		20	50	mV
$\Delta V_{OUT}/\Delta V_{IN}$	Line regulation	$V_{SET}+1\text{V} \leq V_{IN} \leq 24\text{V}$, $I_{OUT}=20\text{mA}$		0.05	0.20	%/V
V_{DIF}	Dropout Voltage	$I_{OUT}=20\text{mA}$		0.20	0.40	V
$\Delta V_{OUT}/\Delta T_{opt}$	Output Voltage Temperature Coefficient	$V_{IN}=V_{SET}+2.0\text{V}$, $I_{OUT}=20\text{mA}$, $-40^{\circ}\text{C} \leq T_{opt} \leq 105^{\circ}\text{C}$		± 100		ppm/ $^{\circ}\text{C}$
I_{SC}	Short Current Limit	$V_{OUT}=0\text{V}$		45		mA
V_{CEH}	CE “H” Input Voltage		2.1		V_{IN}	V
V_{CEL}	CE “L” Input Voltage		0		0.3	V
T_{SD}	Thermal Shutdown Temperature	Junction Temperature		150		$^{\circ}\text{C}$
T_{SR}	Thermal Shutdown Released Temperature	Junction Temperature		125		$^{\circ}\text{C}$

The above specifications measured at the condition of $V_{OUT}=V_{ADJ}$.

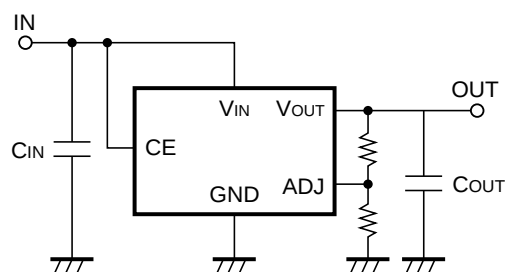
RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

TYPICAL APPLICATIONS

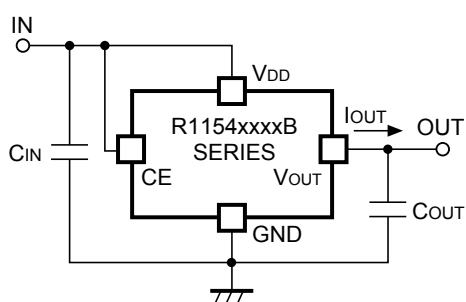


Fixed Output Voltage Type

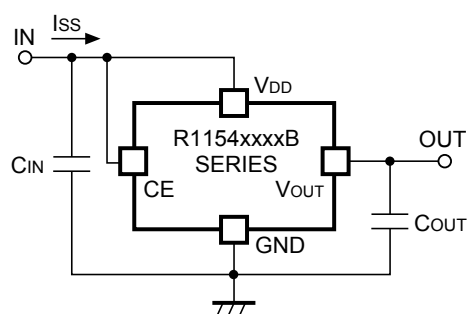


Adjustable Type

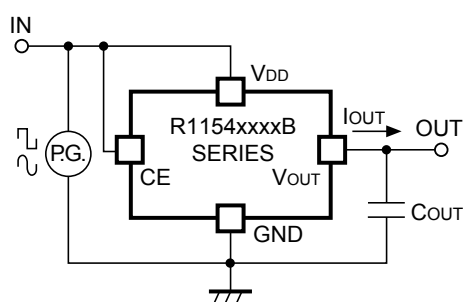
TEST CIRCUITS



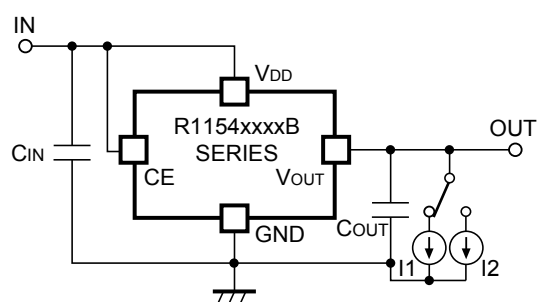
R1154xxxxB Standard Test Circuit



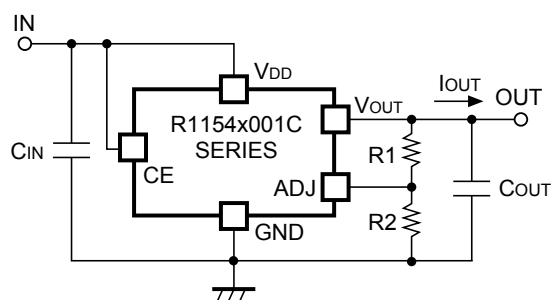
R1154xxxxB Supply Current Test Circuit



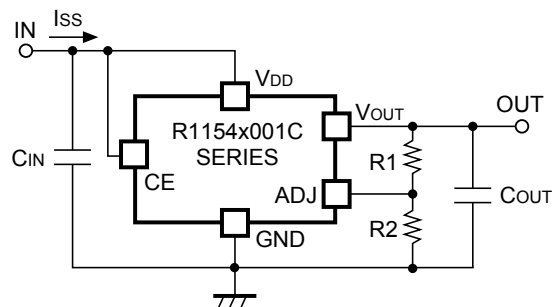
R1154xxxxB Input Transient Response Test Circuit



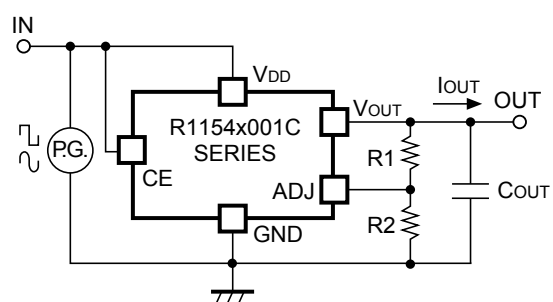
R1154xxxxB Load Regulation Test Circuit



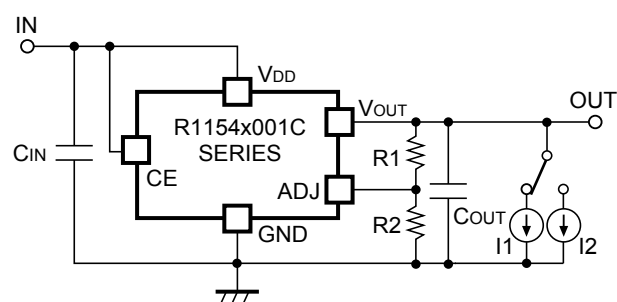
R1154x001C Standard Test Circuit



R1154x001C Supply Current Test Circuit



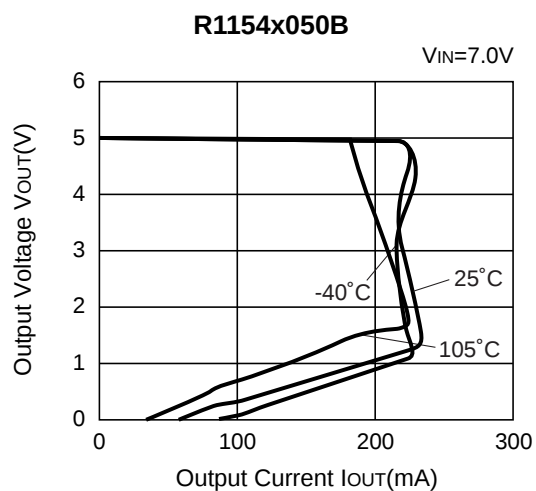
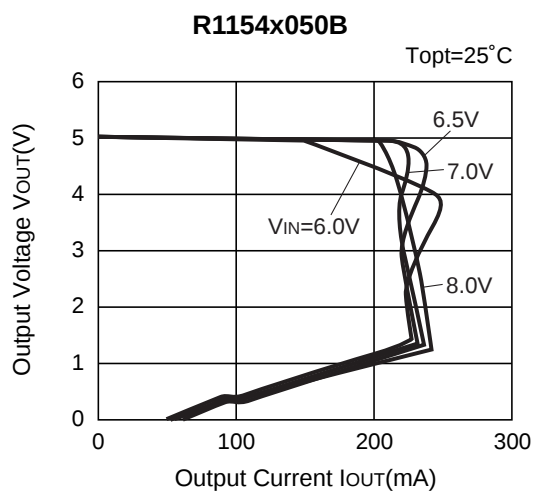
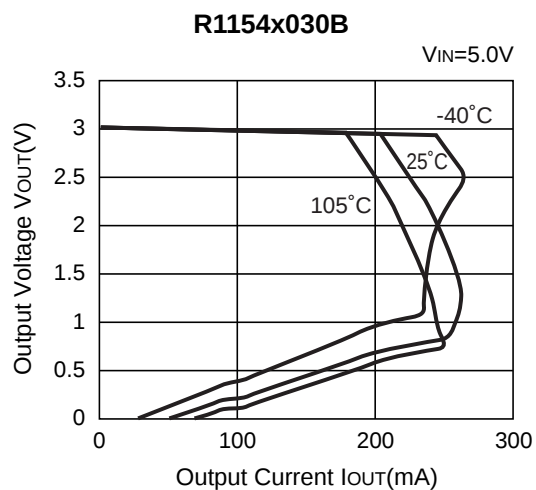
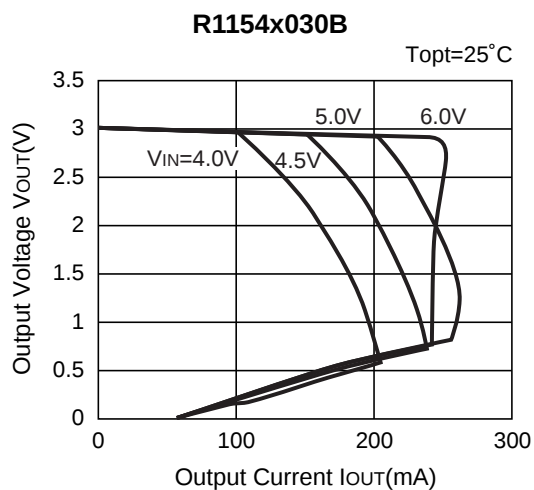
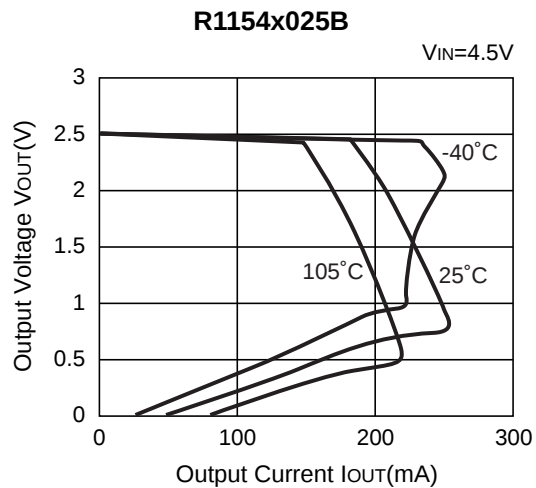
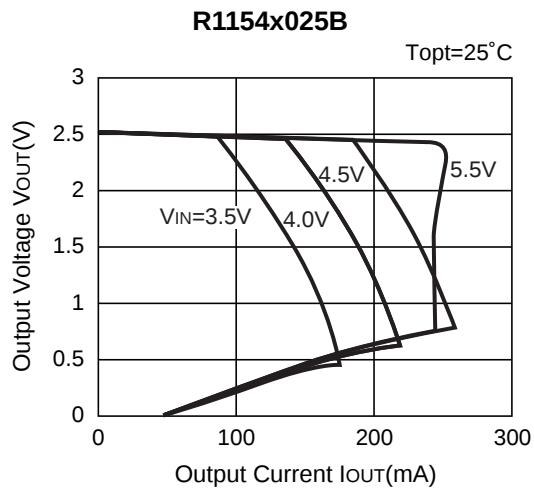
R1154x001C Input Transient Response Test Circuit

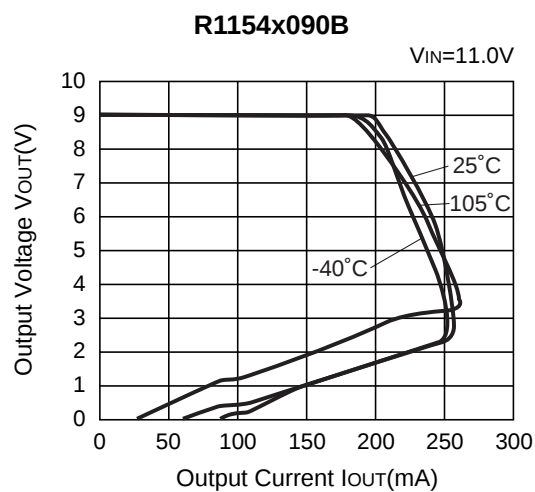
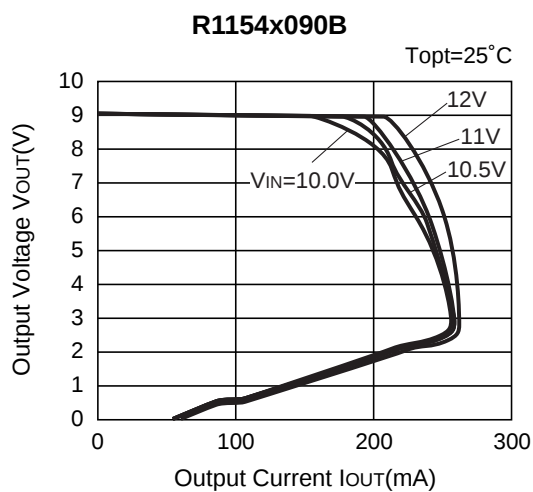


R1154x001C Load Transient Response Test Circuit

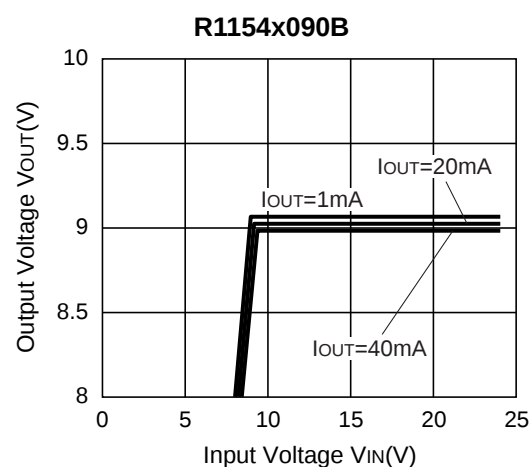
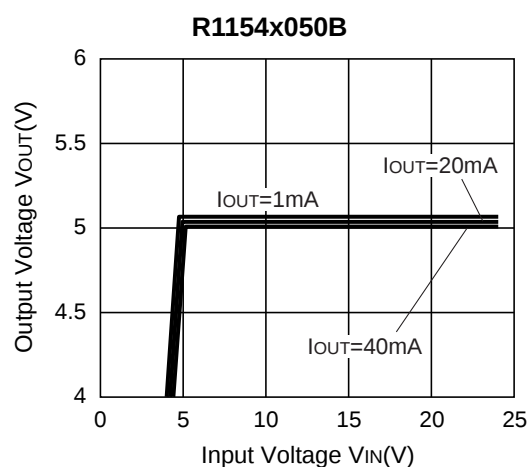
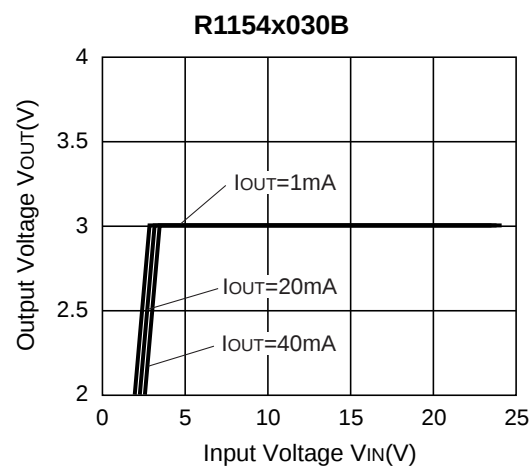
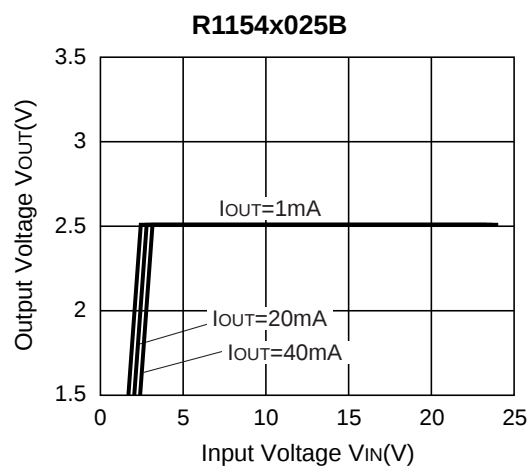
TYPICAL CHARACTERISTICS

1) Output Voltage vs. Output Current

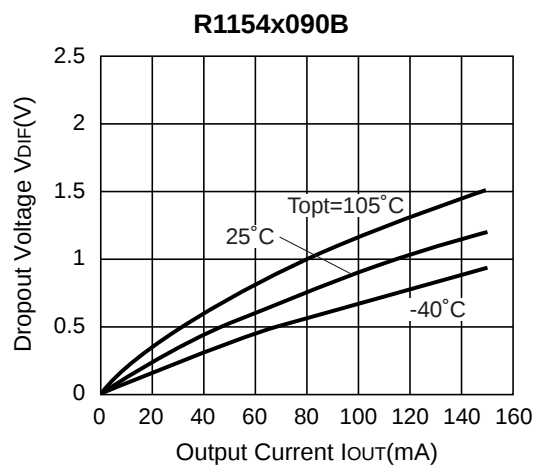
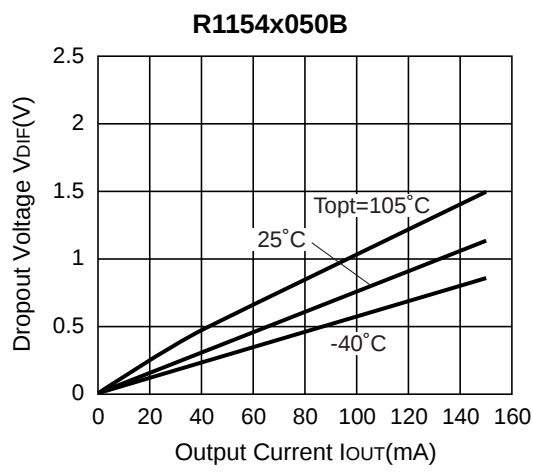
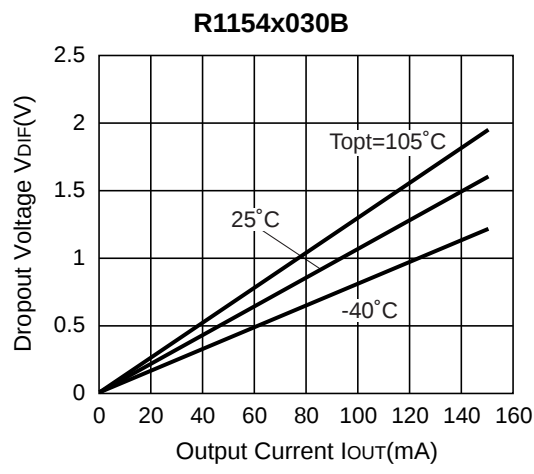
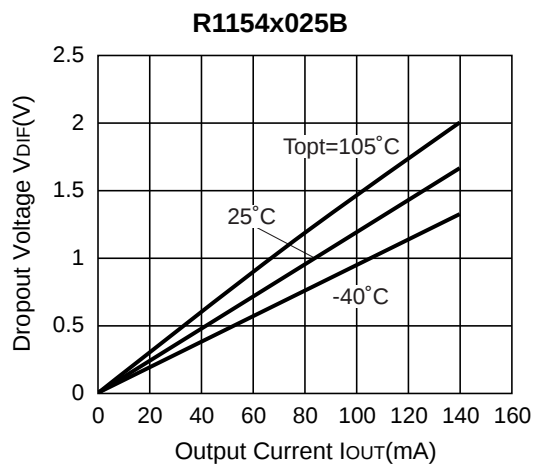




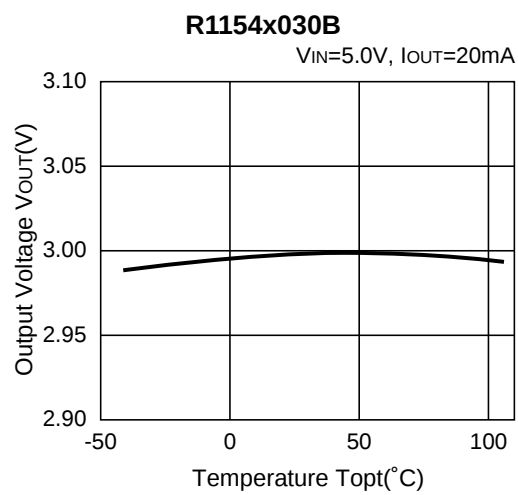
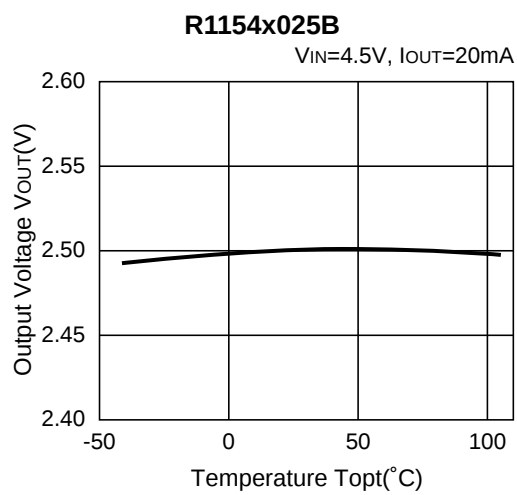
2) Input Voltage vs. Output Voltage ($T_{opt}=25^{\circ}\text{C}$)

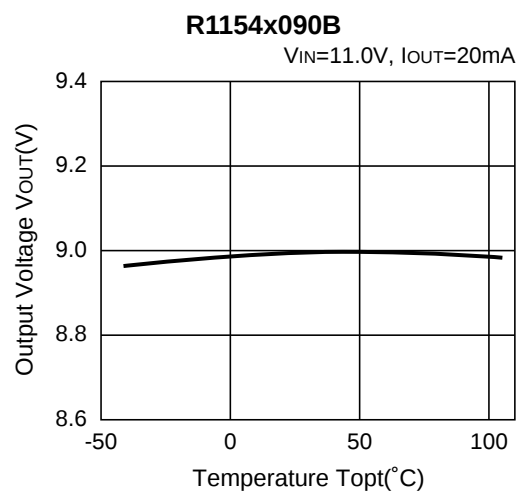
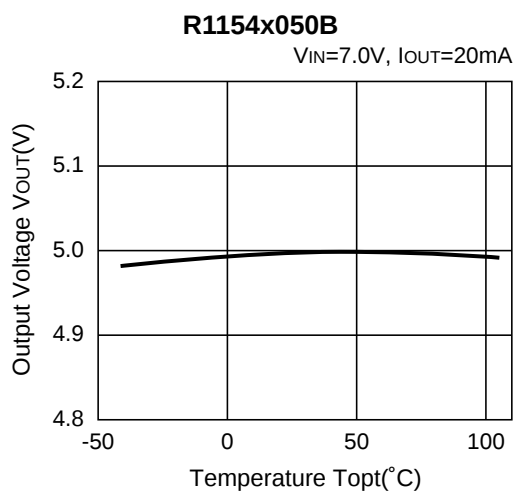


3) Dropout Voltage vs. Output Current

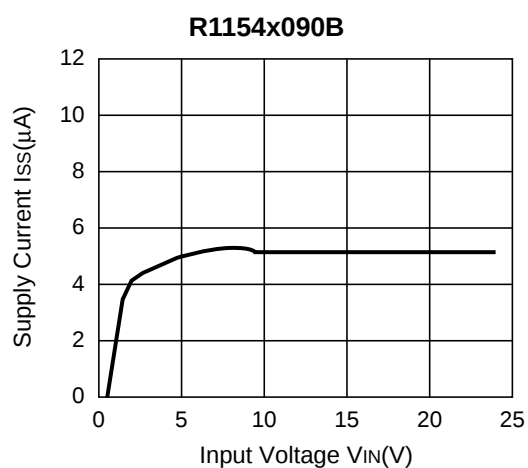
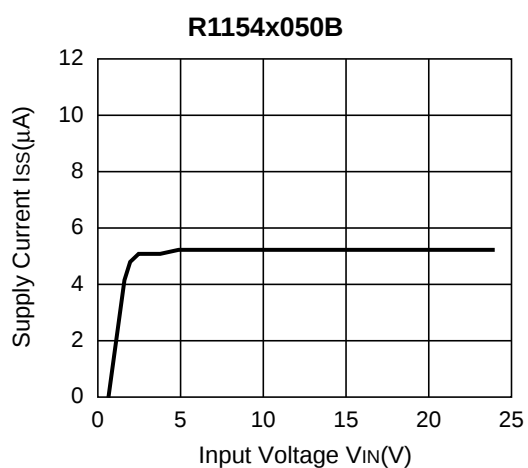
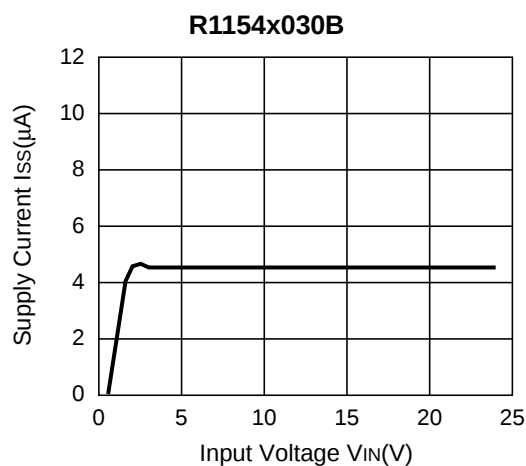
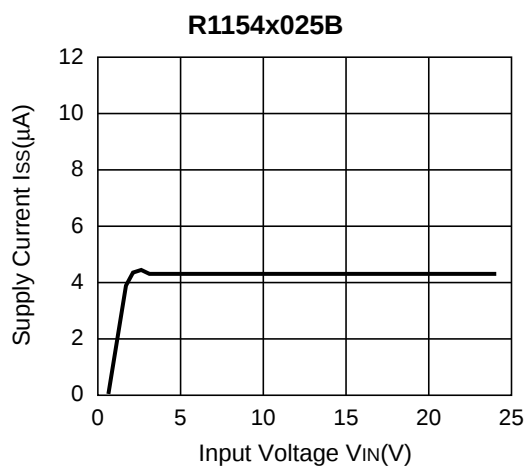


4) Output Voltage vs. Temperature

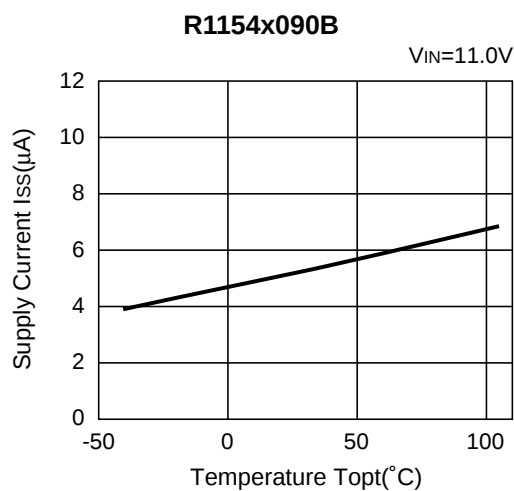
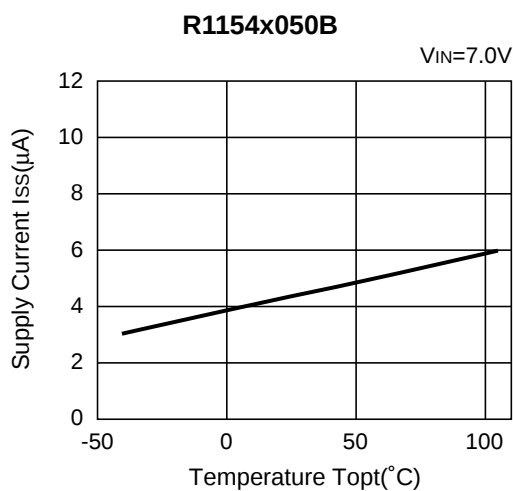
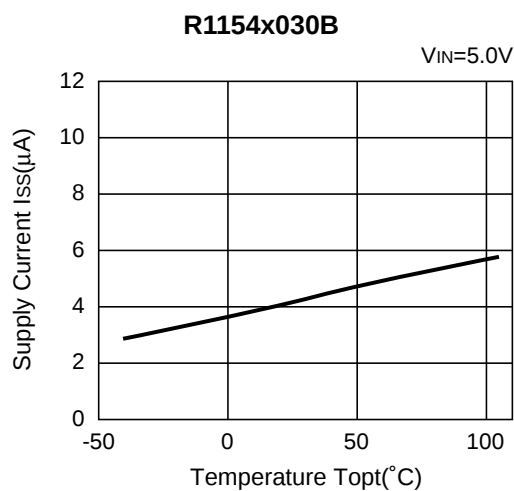
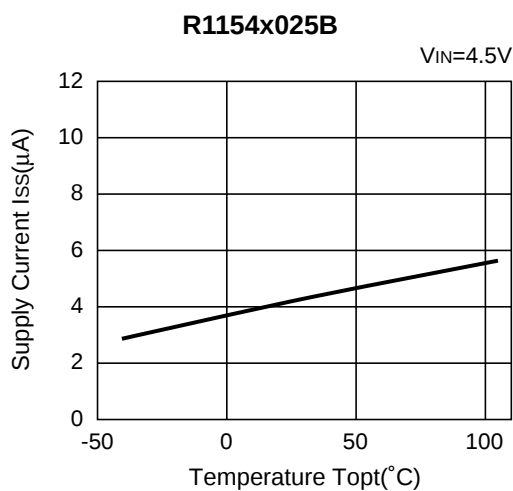




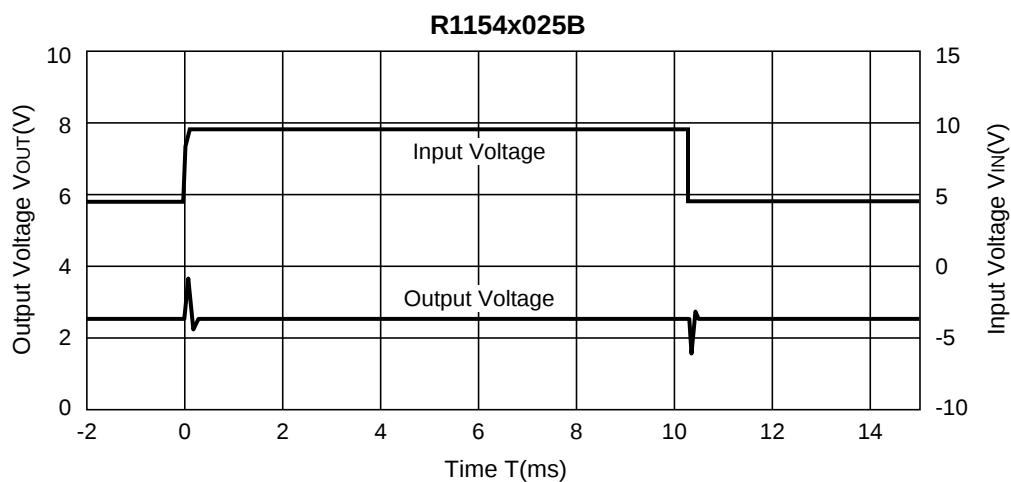
5) Supply Current vs. Input Voltage ($T_{opt}=25^{\circ}C$)

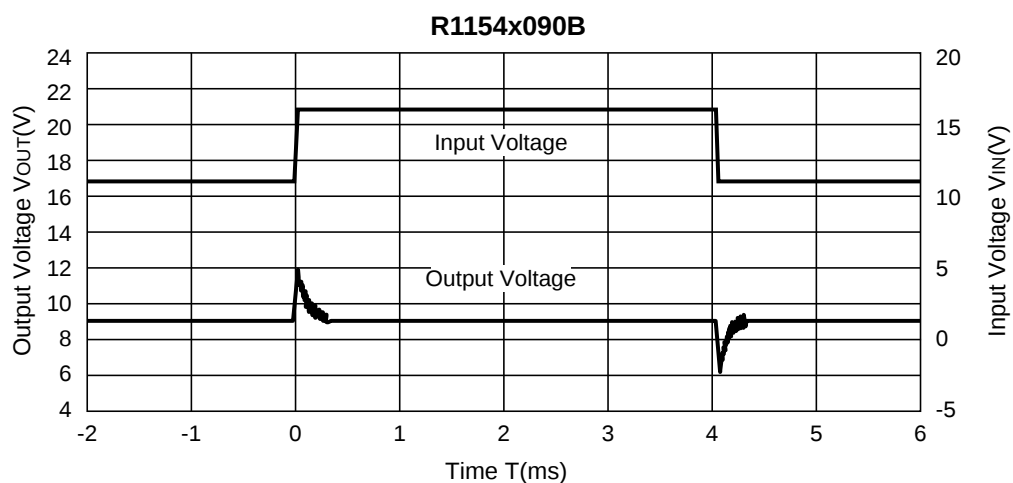
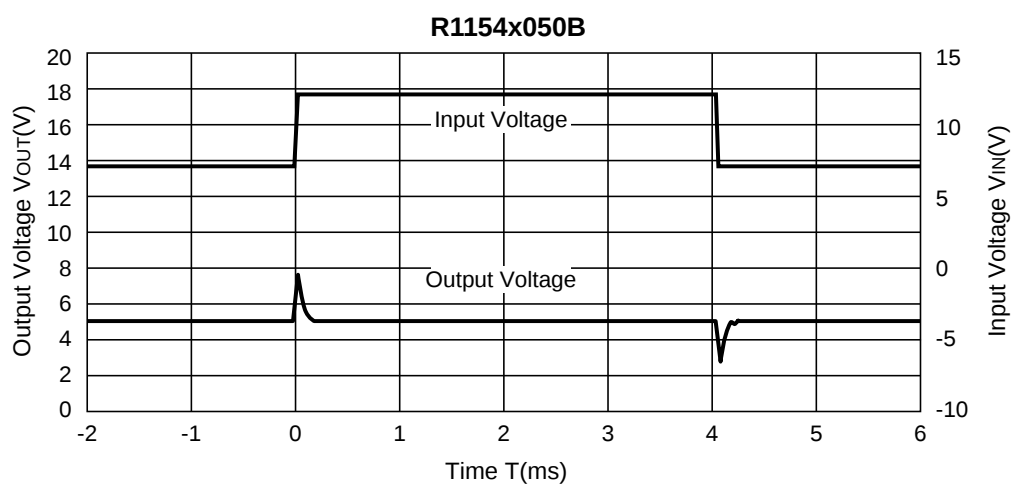
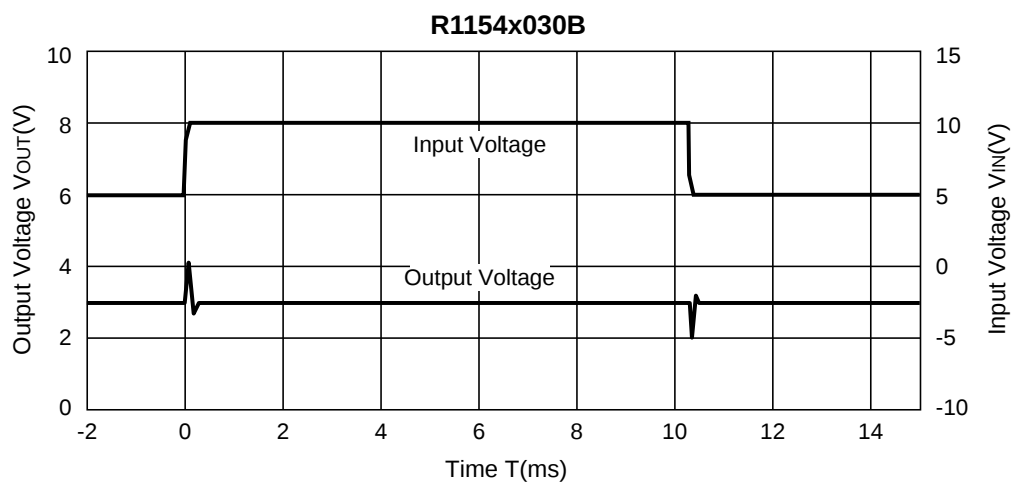


6) Supply Current vs. Temperature



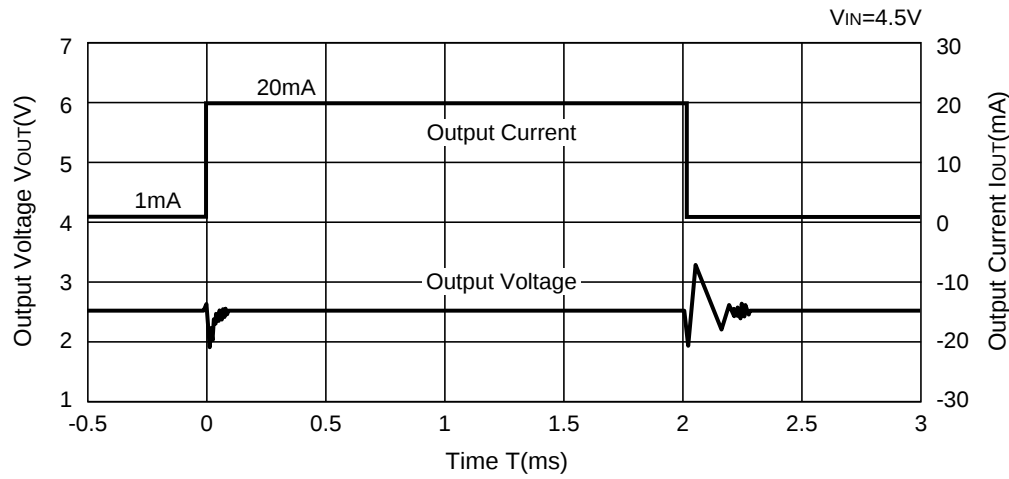
7) Input Transient Response ($I_{OUT}=20mA$, $C_{OUT}=0.1\mu F$, $T_{opt}=25^{\circ}C$)



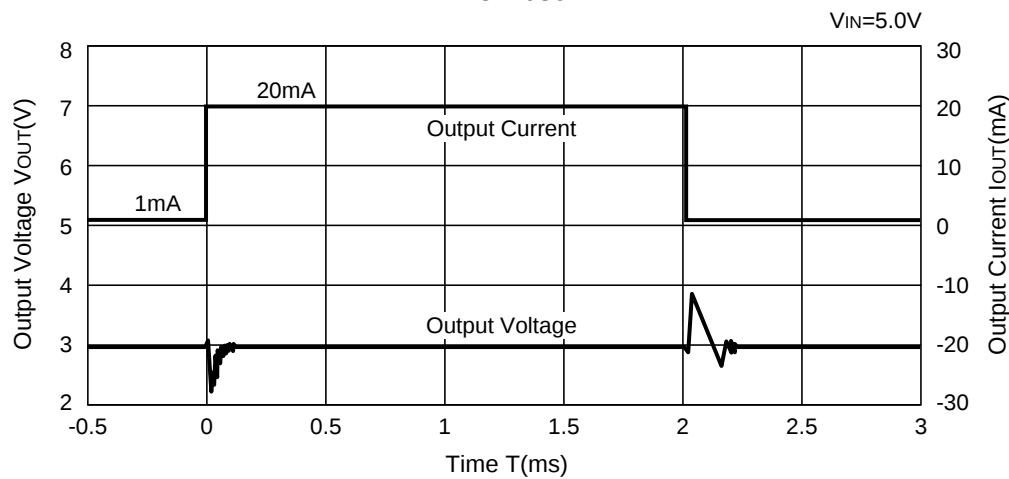


8) Load Transient Response ($C_{OUT}=0.1\mu F$, $T_{opt}=25^{\circ}C$)

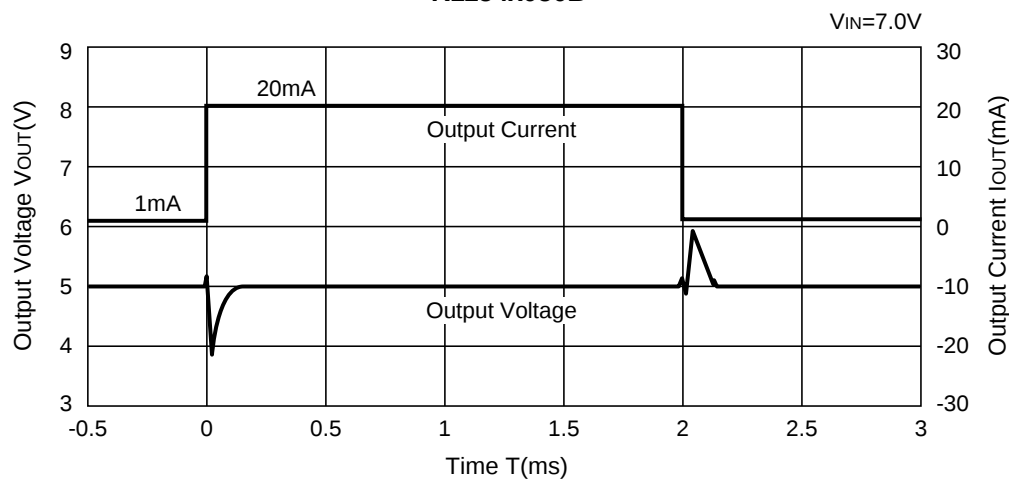
R1154x025B

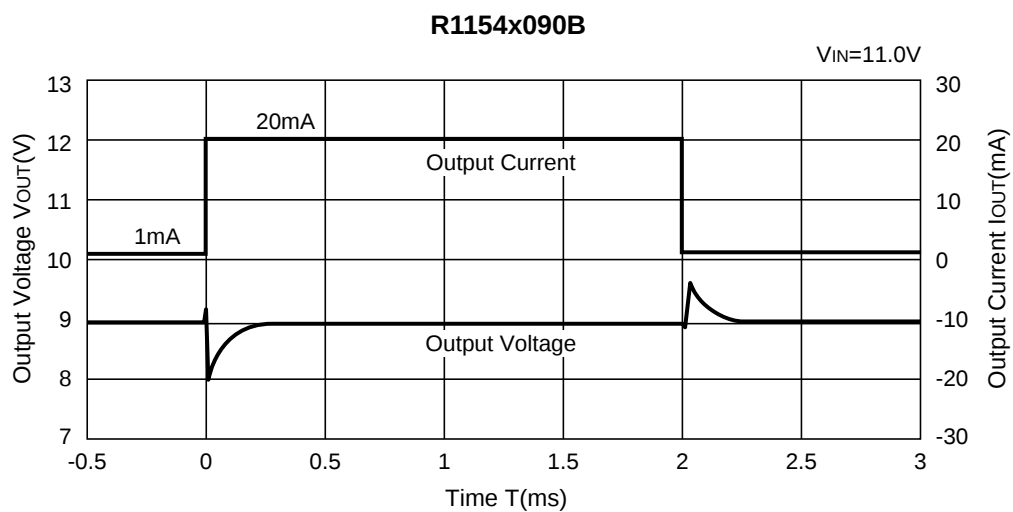


R1154x030B

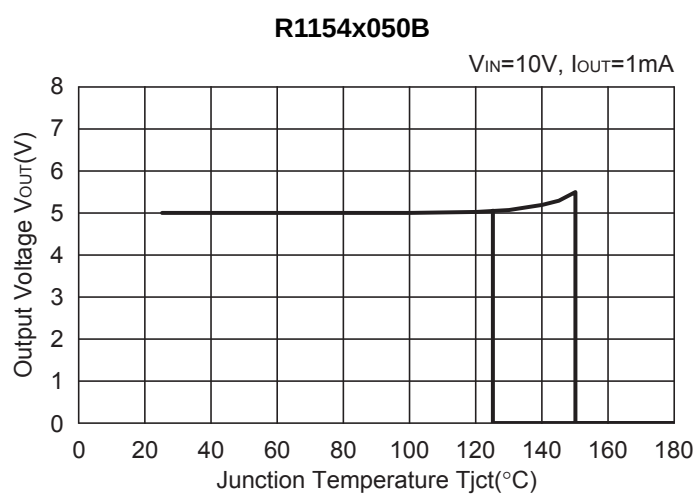


R1154x050B





9) Thermal Shutdown Characteristics

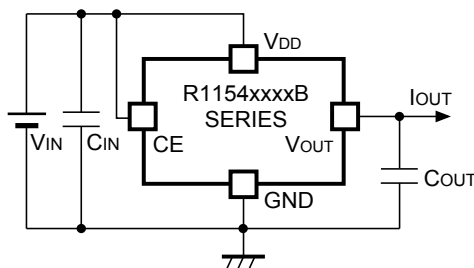


TECHNICAL NOTES

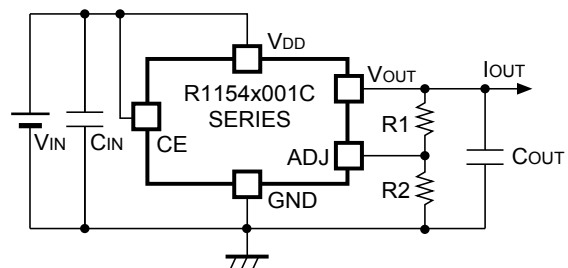
Phase Compensation

Phase Compensation of the R1154x Series has been made internally for stable operation even though the load current would vary. Therefore, without the capacitors, C_{IN} and C_{OUT} , the output voltage is regulated, however, for more stable operation, use capacitors as C_{IN} and C_{OUT} . Especially, if the input line is long and impedance is high, C_{IN} is necessary, moreover, if you use C_{OUT} , transient response will be improved. Recommended value is in the range from $0.1\mu\text{F}$ to $2.2\mu\text{F}$. Wiring should be made as short as possible.

Connect the capacitor, C_{IN} between V_{DD} pin and GND pin and C_{OUT} between V_{OUT} and GND as close as possible.



R1154xxxxB Typical Application



R1154xxxxC Typical Application

Thermal Shutdown

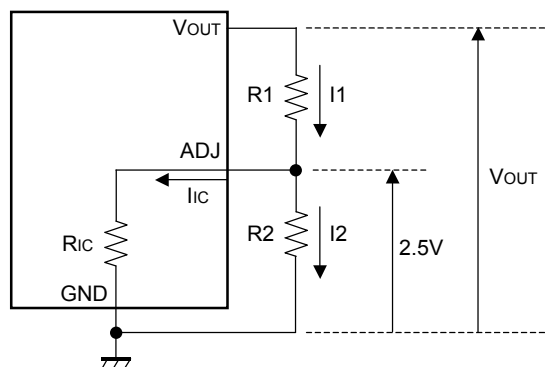
Thermal shutdown function is included in the R1154x Series, if the junction temperature is equal or more than $+150^{\circ}\text{C}$ (Typ.), the operation of regulator would stop. After that, when the junction temperature is equal or less than $+125^{\circ}\text{C}$ (Typ.), the operation of regulator would restart. Unless the cause of rising temperature would remove, the regulator repeats on and off, and output waveform would be like consecutive pulses.

Chip Enable Circuit

Do not make voltage level of chip enable pin keep floating level, or in between V_{IH} and V_{IL} . Unless otherwise, Output voltage would be unstable or indefinite, or unexpected current would flow internally.

* Technical Notes on Output Voltage Setting of C type

Figure 1. Adjustable Regulator (C type)



The Output Voltage of Regulator in R1154xxxxC may be adjustable for any output voltage between its 2.5V reference and its V_{DD} setting level. An external pair of resistors is required, as shown in Figure 1. The complete equation for the output voltage is described step by step as follows;

$$I_1 = I_{IC} + I_2 \dots\dots\dots (1)$$

$$I_2 = 2.5/R_2 \dots\dots\dots (2)$$

Thus,

$$I_1 = I_{IC} + 2.5/R_2 \dots\dots\dots (3)$$

Therefore,

$$V_{OUT} = 2.5 + R_1 \times I_1 \dots\dots\dots (4)$$

Put Equation (3) into Equation (4), then

$$\begin{aligned} V_{OUT} &= 2.5 + R_1(I_{IC} + 2.5/R_2) \\ &= 2.5(1 + R_1/R_2) + R_1 \times I_{IC} \dots\dots\dots (5) \end{aligned}$$

In 2nd term, or $R_1 \times I_{IC}$ will produce an error in V_{OUT} .

In Equation (5),

$$I_{IC} = 2.5/R_{IC} \dots\dots\dots (6)$$

$$\begin{aligned} R_1 \times I_{IC} &= R_1 \times 2.5/R_{IC} \\ &= 2.5 \times R_1/R_{IC} \dots\dots\dots (7) \end{aligned}$$

For better accuracy, choosing R_1 ($\ll R_{IC}$) reduces this error.

R_{IC} of the R1154x001C is approximately Typ.17M Ω ($T_a=25^\circ\text{C}$, guaranteed by Design Engineering).

R_{IC} could be affected by the temperature, therefore evaluate the circuit taking the actual conditions of use into account when deciding the resistance values for R_1 and R_2 .



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